

PRODUCT DATASHEET Julia-A series





Ordering number F11947 Description F11947_Julia-A-XP

Family Julia **FWHM** 108 +164 degrees Lens 90 %

Type Efficiency LED XP-E cd/lm Color Gerber File Available Transparent

Diameter 18.8 mm 4.66 mm Height

http://www.ledil.fi/Julia_Uniform_Wide_Angle_Illumination_-_Ide Round Style Optic Material **PMMA**

Holder Material

Pin, glue Fastening Status Ready

Ordering number FA11948 Description FA11948_Julia-A-XP-tape

Round

Family **FWHM** 108 +164 degrees

Type Lens Efficiency 90 % **LED** XP-E cd/lm

Gerber File Available Color Transparent

Diameter 18.8 mm 4.81 mm Height http://www.ledil.fi/Julia_Uniform_Wide_Angle_Illumination_-_Ide

Optic Material **PMMA** Holder Material Pin, tape Fastening

Style

Status Ready

ence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.



PRODUCT DATASHEET Julia-A series



GENERAL INFORMATION

- Product series especially designed & optimized for XP-E series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Lens material optical grade PMMA with high UV and temperature resistance (105 degrees of Celcius / 220 degrees of Fahrenheit). Allows use of high current and temperature conditions.

Please find more information about used material from below:

http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf

- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf
- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.

NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

